Declaration For U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

names are listed	below) of the sul	piect matter which is claimed	and for which a patent i	an original, first and joint invent is sought on the invention entitle	d
		OSENSITIVE RESIN COM FORMING PATTERN	APOSITION, POSITI	VE PHOTOSENSITIVE DRY	F.T.T.d.I
the specification	of which is attac	hed hereto unless the followi	ng is checked:		
	was filed on	October 15, 2001	as Unite	d States Application Number or l	PCT International
x	Application Nu	mber <u>09/976278</u>		and was amended on	
larana d	(if applicable).				
	at I have reviewe ent referred to ab		s of the above-identified	specification, including the clair	n(s), as amended
I acknowledge th	he duty to disclose	e information which is materia	al to patentability as defir	ned in Title 37, Code of Federal R	egulations, § 1.56.
inventor's certif	icate listed below	nefits under Title 35, United and have also identified belotion on which priority is claim	ow any foreign application	(d) of any foreign application(s) on for patent or inventor's certification.	for patent or cate having a fil-
	2000)-314987	Japan	16/10/2000	Priority Claimed
(Eist prior foreign		(Number)	(Country)	(Day/Month/Year Filed)	Yes No
applications. See note A on back of		(Number)	(Country)	(Day/Month/Year Filed)	_
this page)		(Number)	(Country)	(Day/Month/Year Filed)	_ _ □ Yes □ No
		(Number)	(Country)	(Day/Month/Year Filed)	
(See note B on	back of this page	☐ See attached	list for additional prior t	foreign applications	
I hereby claim t	he benefit under	Title 35, United States Code,	§ 119(e) of any United	States provisional application(s)	listed below.
		(Application Number)		(Filing Date)	_
		(Application Number)		(Filing Date)	_
subject matter of the first paragra ity as defined in	of each of the clai uph of Title 35, Un uph Title 37, Code o	ms of this application is not onited States Code, § 112, I ac	disclosed in the prior Un knowledge the duty to do which became available	ites application(s) listed below are ited States application in the manisclose information which is mate between the filing date of the p	nner provided by erial to patentabil-
(List Prior U. Applications)	D	lication Serial Number)	(Filing Date)	(Status) (patented, pendi	ng, abandoned)
	(App	olication Serial Number)	(Filing Date)	(Status) (patented, pendi	ng, abandoned)
	at the following at ace connected there		prosecute this application	and to transact all business in the	ne Patent and

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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